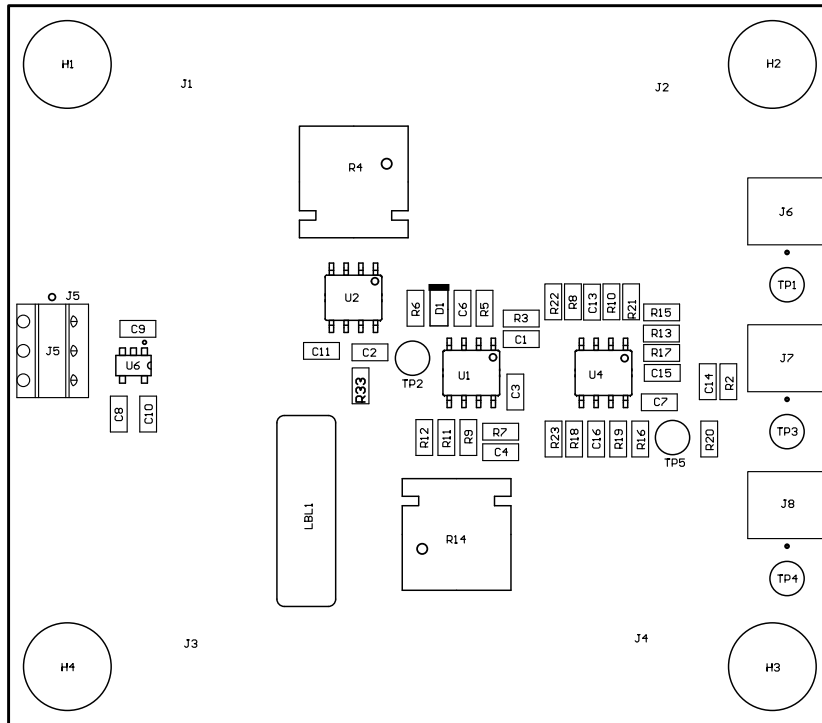


| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00439 | REV: E2 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Paste | TID #: | | |
| PLOT NAME = TIDA-00439.GTP | GENERATED : 6/8/2015 | 5:53:10 PM | TEXAS INSTRUMENTS |

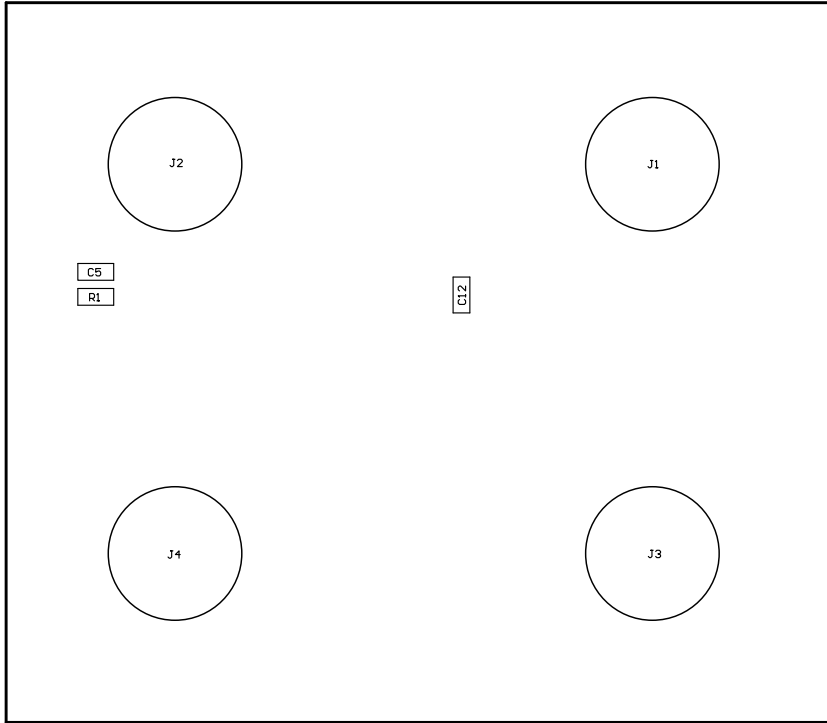
| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00439 | REV: E2 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Paste | TID #: | | |
| PLOT NAME = TIDA-00439.GBP | GENERATED : 6/8/2015 | 5:53:10 PM | TEXAS INSTRUMENTS |

- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



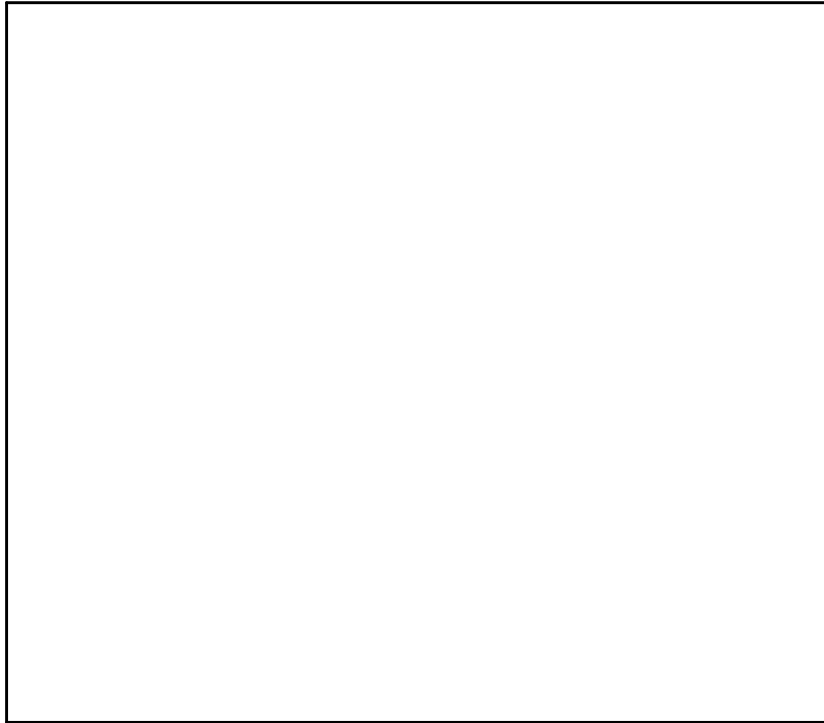
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

| | | | |
|----------------------------|----------------------|------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: TIDA-00439 | REV: E2 | SUN REV: Not In VersionControl |
| M5 Assembly Top | TID #: | | |
| PLOT NAME = TIDA-00439.GM5 | GENERATED : 6/8/2015 | 5:53:56 PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

| | | | |
|-----------------------------|---------------------------|------------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-00439 | REV: E2 | SUN REV: Not In VersionControl |
| | TID #: M6 Assembly Bottom | | |
| PLOT NAME = TIDA-00439.GM6 | GENERATED : 6/8/2015 | 5:53:56 PM | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00439 | REV: E2 | SUN REV: Not In VersionControl |
| LAYER NAME = M1 Board Outline | TID #: | | |
| PLOT NAME = TIDA-00439.GM1 | GENERATED : 6/8/2015 | 3:41:02 PM | TEXAS INSTRUMENTS |

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